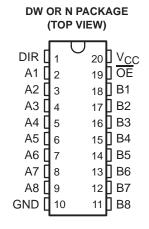
SN74ALS638A, SN74ALS639A, SN74AS638A, SN74AS639 OCTAL BUS TRANSCEIVERS

SDAS123A - DECEMBER 1983 - REVISED JANUARY 1995

- Bidirectional Bus Transceivers in High-Density 20-Pin Packages
- Choice of True or Inverting Logic
- A-Bus Outputs Are Open Collector;
 B-Bus Outputs Are 3 State
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (N) 300-mil DIPs

DEVICE	A OUTPUT	B OUTPUT	LOGIC
SN74ALS638A, SN74AS638A	Open collector	3 state	Inverting
SN74ALS639A, SN74AS639	Open collector	3 state	True



description

These octal bus transceivers are designed for asynchronous two-way communication between open-collector and 3-state buses. The devices transmit data from the A bus (open-collector) to the B bus (3 state) or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so the buses are isolated.

The -1 version of SN74ALS638A is identical to the standard version, except that the recommended maximum I_{OL} is increased to 48 mA.

The SN74ALS638A, SN74ALS639A, SN74AS638A, and SN74AS639 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE

	INP	UTS	OPERATION					
	ŌĒ	DIR	SN74ALS638A SN74AS638A	SN74ALS639A SN74AS639				
Ī	L	L	B data to A bus	B data to A bus				
	L	Н	A data to B bus	A data to B bus				
	Н	Χ	Isolation	Isolation				

logic symbols†

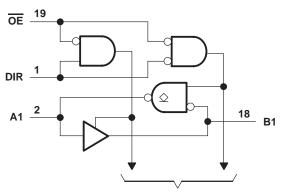
SN74ALS638A, SN74AS638A SN74ALS639A, SN74AS639 19 OE OE G3 G3 DIR 3 EN1 [BA] DIR 3 EN1 [BA] 3 EN2 [AB] 3 EN2 [AB] 18 18 **☆1 B**1 **∆1** ◁ **B**1 \triangleleft 2▽ 17 17 3 B2 B2 16 4 16 В3 **A3 B3** 5 15 5 15 **B4** B4 6 14 6 14 Α5 **B5 A5 B5** 7 13 13 **A6 B6 A6 B6** 8 12 8 12 **B7 B7** Α7 9 11 9 11 **B8 B8 8**A **A8**

To Seven Other Transceivers

logic diagrams (positive logic)

SN74ALS638A, SN74AS638A OE 18

SN74ALS639A, SN74AS639



To Seven Other Transceivers

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}	
Input voltage, V _I : All inputs	7 V
A-bus I/O ports	7 V
B-bus I/O ports	
Operating free-air temperature range, T _A : SN74ALS638A, SN74ALS639A	0°C to 70°C
Storage temperature range	−65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

SDAS123A - DECEMBER 1983 - REVISED JANUARY 1995

recommended operating conditions

				'4ALS63 '4ALS63		UNIT
			MIN	NOM	MAX	
Vcc	Supply voltage		4.5	5	5.5	V
VIH	High-level input voltage		2			V
VIL	V _{IL} Low-level input voltage				0.8	V
Vон	High-level output voltage	A ports			5.5	V
IOH	High-level output current	B ports			-15	mA
la.	Low lovel output ourrent	A or B ports			24	mA
IOL	L Low-level output current A or B ports				48†	IIIA
TA	Operating free-air temperature		0		70	°C

[†] Applies only to the SN74ALS638A-1 version and only if V_{CC} is between 4.75 V and 5.25 V

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	ETER TEST CONDITIONS				SN74ALS638A SN74ALS639A				
				MIN	TYP‡	MAX				
٧ıK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.5	V			
loh	A ports	$V_{CC} = 4.5 V,$	V _{OH} = 5.5 V			0.1	mA			
	$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$ IC		$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	<u>)</u>					
V_{OH}	B ports	V _{CC} = 4.5 V	$I_{OH} = -3 \text{ mA}$	2.4	3.2		V			
		VCC = 4.5 V	$I_{OH} = -15 \text{ mA}$	2						
			I _{OL} = 12 mA		0.25	0.4				
VOL	A or B ports	$V_{CC} = 4.5 V$	I _{OL} = 24 mA		0.35	0.5	V			
			I _{OL} = 48 mA [†]		0.35	0.5				
1.	Control inputs	V 55V	V _I = 7 V			0.1	A			
Ц	A or B ports	$V_{CC} = 5.5 V$	V _I = 5.5 V			0.1	mA			
	Control inputs	V 55V	V 0.7.V			20	^			
lН	A or B ports§	$V_{CC} = 5.5 V,$	V _I = 2.7 V				μΑ			
L	Control inputs	V 55V	V/- 0.4 V/			-0.1	A			
ΙΙL	A or B ports§	$V_{CC} = 5.5 V$,	V _I = 0.4 V			-0.1	mA			
Io¶	B ports	V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	mA			
			Outputs high		18	30				
	SN74ALS638A	$V_{CC} = 5.5 V$	Outputs low		26	41				
1			Outputs disabled		16	30				
ICC			Outputs high		25	40	mA			
	SN74ALS639A	$V_{CC} = 5.5 V$	Outputs low		30	50	1			
			Outputs disabled		33	54				

 $^{^\}dagger$ Applies only to the SN74ALS638A-1 version and only if V_{CC} is between 4.75 V and 5.25 V



 $[\]ddagger$ All typical values are at VCC = 5 V, TA = 25°C. \$ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

SN74ALS638A, SN74ALS639A, SN74AS638A, SN74AS639 OCTAL BUS TRANSCEIVERS

SDAS123A - DECEMBER 1983 - REVISED JANUARY 1995

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _L = 50 R _L = 68 R1 = R	80 Ω (A	outputs), Ω (B outp	uts),	UNIT	
			SN74AL	S638A	SN74AL	S639A		
			MIN	MAX	MIN	MAX		
t _{PLH}	А	_	2	12	2	12	ns	
^t PHL	٨	В	2	12	2	12	115	
^t PLH	В	Δ.	8	25	10	30	ns	
^t PHL	Ь	А	8	30	5	22	115	
^t PLH			5	25	10	30	no	
^t PHL	ŌĒ	А	10	45	10	35	ns	
^t PZH			5	20	6	21		
tPZL	ŌĒ	В	5	22	8	25	ns	
^t PHZ	ŌĒ	В	2	10	2	10		
^t PLZ	OE .	D	3	15	3	16	ns	

T For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}	7 V
Input voltage, V _I : All inputs	7 V
A-bus I/O ports	
B-bus I/O ports	
Operating free-air temperature range, T _A : SN74AS638A, SN74AS639	0°C to 70°C
Storage temperature range	65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

				74AS638 174AS63		UNIT
			MIN	NOM	MAX	
VCC	Supply voltage		4.5	5	5.5	V
V _{IH} High-level input voltage						V
V _{IL}	Low-level input voltage				0.8	V
Vон	High-level output voltage	A ports			5.5	V
ІОН	High-level output current	B ports			-15	mA
l _{OL}	Low-level output current	A or B ports			64	mA
TA	Operating free-air temperature		0		70	°C

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	PARAMETER TEST CONDITIONS				3A 39	UNIT
				MIN	TYP [†]	MAX	
VIK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2	V
loh	A ports	V _{CC} = 4.5 V,	V _{OH} = 5.5 V			0.1	mA
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -2 \text{ mA}$	V _{CC} -2	!		
VOH	B ports	V-5-45V	IOH = -3 mA	2.4	3.2		V
		$V_{CC} = 4.5 V$	$I_{OH} = -15 \text{ mA}$	2.4			
VOL	A or B ports	V _{CC} = 4.5 V,	I _{OL} = 64 mA		0.35	0.55	V
	Control inputs	V 55V	V _I = 7 V			0.1	Λ
'	A or B ports	$V_{CC} = 5.5 V$	V _I = 5.5 V			0.1	mA
	Control inputs	V 55V				20	^
ΙΗ	A or B ports‡	$V_{CC} = 5.5 V$,	V _I = 2.7 V			70	μΑ
	Control inputs	V 55V	V 0.4V			-0.5	Δ
¹IL	A or B ports [‡]	$V_{CC} = 5.5 V$,	V _I = 0.4 V			-0.75	mA
IO§		V _{CC} = 5.5 V,	V _O = 2.25 V	-50		-150	mA
			Outputs high		24	54	
	SN74AS638A	V _{CC} = 5.5 V	Outputs low		75	122	
١.			Outputs disabled		37	61	^
Icc	cc		Outputs high		56	92	mA
	SN74AS639	V _{CC} = 5.5 V	Outputs low		95	154	
			Outputs disabled		62	100	

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 4 C _L = 50 R _L = 50 R1 = R2 T _A = MI	UNIT			
			SN74A	S638A	SN74A	S639	
			MIN	MAX	MIN	MAX	
t _{PLH}	А	В	2	7	2	9.5	ns
^t PHL	A	Ь	2	6.5	2	9	113
^t PLH	В		5	20	5	22	ns
^t PHL	В	А	2	7	2	9	115
t _{PLH}	ŌĒ		5	19	5	21.5	20
^t PHL	OE	А	2	9	2	11.5	ns
^t PZH			2	8	2	10.5	
t _{PZL}	ŌĒ	В	2	10	2	10.5	ns
[†] PHZ	ŌĒ	В	2	7	2	7	ns
^t PLZ	OE	В	2	10	2	10.5	

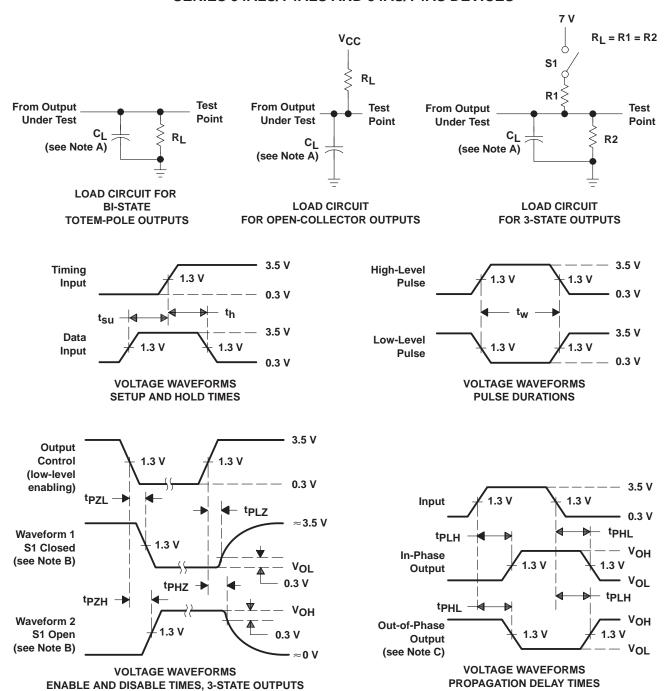
[¶] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

[§] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, los.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
 - D. All input pulses have the following characteristics: $PRR \le 1$ MHz, $t_f = t_f = 2$ ns, duty cycle = 50%.
 - E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



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PACKAGING INFORMATION

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN74ALS638AN	ACTIVE	PDIP	N	20	20	RoHS & Non-Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS638AN	Samples
SN74ALS639ADW	ACTIVE	SOIC	DW	20	25	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS639A	Samples
SN74ALS639AN	ACTIVE	PDIP	N	20	20	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS639AN	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

www.ti.com 21-Dec-2024

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PACKAGE MATERIALS INFORMATION

www.ti.com 5-Jan-2022

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
SN74ALS638AN	N	PDIP	20	20	506	13.97	11230	4.32
SN74ALS639ADW	DW	SOIC	20	25	507	12.83	5080	6.6
SN74ALS639AN	N	PDIP	20	20	506	13.97	11230	4.32

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOIC



NOTES:

- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

 2. This drawing is subject to change without notice.

 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
- 5. Reference JEDEC registration MS-013.



SOIC



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOIC



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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